

Floating Electrode (FF-CAP), High Voltage with Flexible Termination COG Dielectric, 500 – 3,000 VDC (Commercial & Automotive Grade)

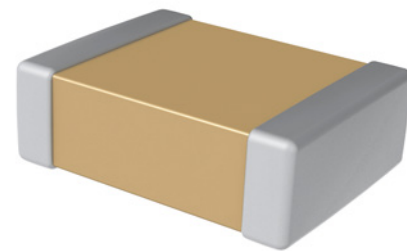
Overview

KEMET's Floating Electrode High Voltage with Flexible Termination capacitor (FF-CAP) combines two existing KEMET technologies– Floating Electrode and Flexible Termination. The floating electrode component utilizes a cascading / serial electrode design configured to form multiple capacitors in series within a single monolithic structure. This unique configuration results in enhanced voltage and ESD performance over standard capacitor designs while allowing for a fail-open condition if mechanically damaged (cracked). The flexible termination component utilizes a conductive silver epoxy between the base metal and nickel barrier layers of KEMET's standard termination system in order to establish pliability while maintaining terminal strength, solderability and electrical performance. Both technologies address the primary failure mode of MLCCs–flex cracks, which are typically the result of excessive tensile and shear stresses produced during board flexure and thermal cycling.

Combined with the COG (NP0) are suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required, exhibit no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient

temperature. Capacitance change is limited to ± 30 ppm/ $^{\circ}\text{C}$ from -55°C to $+125^{\circ}\text{C}$.

Whether under-hood or in-cabin, these capacitors are designed to provide reliable performance in mission and safety critical automotive circuits. Stricter testing protocol and inspection criteria have been established for automotive grade products in recognition of potentially harsh environmental conditions. KEMET automotive grade series capacitors meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.



Ordering Information

C	2225	Y	393	J	C	G	A	C	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ¹	Packaging/ Grade (C-Spec)
	0805 1206 1210 1808 1812 1825 2220 2225	Y = Floating Electrode with Flexible Termination	Two significant digits and number of zeros	B = ± 0.10 pF C = ± 0.25 pF D = ± 0.5 pF F = $\pm 1\%$ G = $\pm 2\%$ J = $\pm 5\%$ K = $\pm 10\%$ M = $\pm 20\%$	C = 500 B = 630 D = 1,000 F = 1,500 G = 2,000 Z = 2,500 H = 3,000	G = COG	A = N/A	C = 100% Matte Sn L = SnPb (5% Pb minimum)	See "Packaging C-Spec Ordering Options Table"

¹ Additional termination finish options may be available. Contact KEMET for details.

¹ SnPb termination finish option is not available on automotive grade product.

Packaging C-Spec Ordering Options Table

Packaging Type	Packaging/Grade Ordering Code (C-Spec)
Commercial Grade¹	
Bulk Bag	Not required (Blank)
7" Reel / Unmarked	TU
13" Reel / Unmarked	7210
Automotive Grade²	
7" Reel	AUTO
13" Reel / Unmarked	AUTO7210

¹ Default packaging is "Bulk Bag". An ordering code C-Spec is not required for "Bulk Bag" packaging.

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. The option to laser mark is not available on these devices. For more information see "Capacitor Marking".

² Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L" x W") and thickness dimension. See "Chip Thickness/Tape & Reel Packaging Quantities" and "Tape & Reel Packaging Information".

² For additional information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information".

² All Automotive packaging C-Specs listed exclude the option to laser mark components. The option to laser mark is not available on these devices. For more information see "Capacitor Marking".

Benefits

- Floating Electrode/fail open design
- AEC-Q200 automotive qualified
- Operating temperature range of -55°C to +125°C
- Superior flex performance (up to 5 mm)
- Capacitance offerings ranging from 1 pF to 0.15 µF
- DC voltage ratings of 500 V, 630 V, 1 KV, 1.5 KV, 2 KV, 2.5 KV and 3 KV
- EIA 0805, 1206, 1210, 1808, 1812, 1825, 2220 and 2225
- Extremely low ESR and ESL
- High ripple current capability
- No capacitance shift with voltage
- Negligible capacitance shift with respect to temperature
- No piezoelectric noise
- Lead (Pb)-Free, RoHS and REACH compliant

Applications

- EV/HEV (drive systems, charging)
- High frequency power converters
- Wide bandgap (WBG), silicon carbide (SiC) and gallium nitride (GaN) systems
- Snubber (high dV/dT)
- Resonant circuits (LLC, Wireless Charging, etc)
- Timing
- Filtering
- ESD protection

Automotive C-Spec Information

KEMET automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET OEM automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below.)

Product Change Notification (PCN)

The KEMET product change notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- Changes in manufacturing site
- Product obsolescence

KEMET Automotive C-Spec	Customer Notification Due To:		Days Prior To Implementation
	Process/Product change	Obsolescence*	
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days minimum
AUTO	Yes (without approval)	Yes	90 days minimum

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

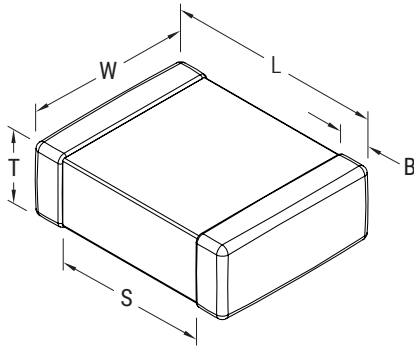
- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design records and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

KEMET Automotive C-Spec	PPAP Level				
	1	2	3	4	5
KEMET assigned ¹	●	●	●	●	●
AUTO			○		

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part number specific PPAP available with customer information included.
- Product family PPAP only

Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0805	2012	2.00 (0.079) ±0.30 (0.012)	1.25 (0.049) ±0.30 (0.012)	See Table 2 for Thickness	0.50 (0.02) ±0.25 (0.010)	0.60 (0.024)	Solder Wave or Solder Reflow
1206	3216	3.30 (0.130) ±0.40 (0.016)	1.60 (0.063) ±0.35(0.013)		0.60 (0.024) ±0.25 (0.010)	1.50 (0.060)	
1210	3225	3.30 (0.130) ±0.40 (0.016)	2.60(0.102) ±0.30(0.012)		0.60 (0.024) ±0.25 (0.010)	1.50 (0.060)	Solder Reflow Only
1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)		0.70 (0.028) ±0.35 (0.014)	2.90 (0.114)	
1812	4532	4.50 (0.178) ±0.40 (0.016)	3.20 (0.126) ±0.30 (0.012)		0.70 (0.028) ±0.35 (0.014)	2.30 (0.091)	
1825	4564	4.60 (0.181) ±0.40 (0.016)	6.40 (0.252) ±0.40 (0.016)		0.70 (0.028) ±0.35 (0.014)	2.30 (0.091)	
2220	5650	5.90 (0.232) ±0.75 (0.030)	5.00 (0.197) ±0.40 (0.016)		0.70 (0.028) ±0.35 (0.014)	3.50 (0.138)	
2225	5664	5.90 (0.232) ±0.75 (0.030)	6.40 (0.248) ±0.40 (0.016)		0.70 (0.028) ±0.35 (0.014)	3.20 (0.126)	

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).

Table 1A – Capacitance Range/Selection Waterfall (0805 – 1808 Case Sizes)

Capacitance	Capacitance Code	Case Size/ Series			C0805Y			C1206Y					C1210Y					C1808Y							
		Voltage Code			C	B	D	C	B	D	F	G	C	B	D	F	G	C	B	D	F	G	Z	H	
		Rated Voltage (VDC)			500	630	1,000	500	630	1,000	1,500	2,000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000	
		Capacitance Tolerance			Product Availability and Chip Thickness Codes See Table 2 for Chip Thickness Dimensions																				
1.0 - 9.1 pF*	109 - 169*	B	C	D	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB	LB	
10 pF	100	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
11 pF	110	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
12 pF	120	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
13 pF	130	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
15 pF	150	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
16 pF	160	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
18 pF	180	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
20 pF	200	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
22 pF	220	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
24 pF	240	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
27 pF	270	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
30 pF	300	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
33 pF	330	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
36 pF	360	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
39 pF	390	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
43 pF	430	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
47 pF	470	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
51 pF	510	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
56 pF	560	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
62 pF	620	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
68 pF	680	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	ES	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
75 pF	750	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EF	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
82 pF	820	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EF	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
91 pF	910	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EF	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB
100 pF	101	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EF	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LC
110 pF	111	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EU	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LC
120 pF	121	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LA	LC
130 pF	131	F	G	J	K	M	DG	DG	DG	ES	ES	ES	ES	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LA	LC
150 pF	151	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EF	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LB	LC
160 pF	161	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EF	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LC	LC
180 pF	181	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EF	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LC	LC
200 pF	201	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EU	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LC	LC
220 pF	221	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EU	EU	FZ	FZ	FZ	FM	FM	LA	LA	LA	LA	LC	LC
240 pF	241	F	G	J	K	M	DG	DG	DG	ES	ES	ES	EU	EU	FZ	FZ	FZ	FK	FK	LA	LA	LA	LA	LC	LC
Capacitance	Capacitance Code	Rated Voltage (VDC)			500	630	1,000	500	630	1,000	1,500	2,000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000	
		Voltage Code			C	B	D	C	B	D	F	G	C	B	D	F	G	C	B	D	F	G	Z	H	
		Case Size/Series			C0805Y			C1206Y					C1210Y					C1808Y							

These products are protected under US Patent 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.

Table 1A – Capacitance Range/Selection Waterfall (0805 – 1808 Case Sizes) cont.

Capacitance	Capacitance Code	Case Size/ Series	C0805Y			C1206Y					C1210Y					C1808Y						
		Voltage Code	C	B	D	C	B	D	F	G	C	B	D	F	G	C	B	D	F	G	Z	H
		Rated Voltage (VDC)	500	630	1,000	500	630	1,000	1,500	2,000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000
		Capacitance Tolerance	Product Availability and Chip Thickness Codes See Table 2 for Chip Thickness Dimensions																			
270 pF	271	F G J K M	DG	DG	DG	ES	ES	ES	EU	EU	FZ	FZ	FZ	FK	FK	LA	LA	LA	LB	LC	LC	
300 pF	301	F G J K M				ES	ES	EF	EU		FZ	FZ	FZ	FK	FK	LA	LA	LA	LB	LC	LC	
330 pF	331	F G J K M				ES	ES	EF	EU		FZ	FZ	FZ	FK	FK	LA	LA	LA	LB	LC	LC	
360 pF	361	F G J K M				ES	ES	EF	EU		FZ	FZ	FZ	FK	FS	LA	LA	LA	LB	LA	LC	
390 pF	391	F G J K M				ES	ES	EF	EU		FZ	FZ	FZ	FK	FS	LA	LA	LA	LB	LA	LC	
430 pF	431	F G J K M				ES	ES	EU	EU		FM	FM	FM	FS	FS	LB	LB	LB	LC	LA		
470 pF	471	F G J K M				ES	ES	EU	EU		FM	FM	FM	FS	FS	LB	LB	LB	LC	LA		
510 pF	511	F G J K M				ES	ES	EU	EU		FM	FM	FM	FS	FS	LB	LB	LB	LC	LB		
560 pF	561	F G J K M				ES	ES	EU	EU		FM	FM	FM	FS	FS	LB	LB	LB	LC	LB		
620 pF	621	F G J K M				EU	EU	EU			FM	FM	FM	FS	FS	LB	LB	LB	LA	LC		
680 pF	681	F G J K M				EU	EU	EU			FM	FM	FM	FS	FS	LB	LB	LB	LA	LC		
750 pF	751	F G J K M				EU	EU	EU			FM	FM	FM	FS		LB	LB	LB	LB			
820 pF	821	F G J K M				EU	EU	EU			FM	FM	FM	FS		LB	LB	LB	LB			
910 pF	911	F G J K M				EU	EU	EU			FM	FM	FM	FS		LB	LB	LB	LB			
1,000 pF	102	F G J K M				EU	EU	EU			FM	FM	FM	FS		LB	LB	LB	LB			
1,100 pF	112	F G J K M									FK	FK	FK	FS		LC	LC	LC	LC			
1,200 pF	122	F G J K M									FK	FK	FK	FK	FS	LC	LC	LC	LC			
1,300 pF	132	F G J K M									FS	FS	FS			LC	LC	LC	LC			
1,500 pF	152	F G J K M									FS	FS	FS			LC	LC	LC	LC			
1,600 pF	162	F G J K M									FS	FS	FS			LC	LC	LC	LC			
1,800 pF	182	F G J K M									FS	FS	FS			LC	LC	LC				
2,000 pF	202	F G J K M									FS	FS	FS			LB	LB	LB				
2,200 pF	222	F G J K M									FS	FS	FS			LB	LB	LB				
2,400 pF	242	F G J K M									FS	FS	FS			LC	LC	LC	LC			
2,700 pF	272	F G J K M									FS	FS	FS			LC	LC	LC	LC			
Capacitance	Capacitance Code	Rated Voltage (VDC)	500	630	1,000	500	630	1,000	1,500	2,000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000
		Voltage Code	C	B	D	C	B	D	F	G	C	B	D	F	G	C	B	D	F	G	Z	H
		Case Size/Series	C0805Y			C1206Y					C1210Y					C1808Y						

These products are protected under US Patent 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.

Table 1B – Capacitance Range/Selection Waterfall (1812 – 2225 Case Sizes)

Capacitance	Capacitance Code	Case Size/ Series	C1812Y								C1825Y								C2220Y								C2225Y							
		Voltage Code	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H				
		Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000				
		Capacitance Tolerance	Product Availability and Chip Thickness Codes See Table 2 for Chip Thickness Dimensions																															
10 pF	100	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
11 pF	110	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
12 pF	120	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
13 pF	130	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
15 pF	150	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
16 pF	160	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
18 pF	180	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
20 pF	200	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
22 pF	220	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
24 pF	240	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
27 pF	270	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
30 pF	300	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
33 pF	330	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
36 pF	360	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
39 pF	390	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
43 pF	430	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
47 pF	470	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
51 pF	510	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
56 pF	560	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
62 pF	620	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
68 pF	680	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
75 pF	750	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
82 pF	820	F G J K M	GB	GB	GB	GB	GB	GB	GB	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
91 pF	910	F G J K M	GD	GD	GD	GD	GD	GD	GD	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
100 pF	101	F G J K M	GD	GD	GD	GD	GD	GD	GD	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
110 pF	111	F G J K M	GD	GD	GD	GD	GD	GD	GD	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
120 pF	121	F G J K M	GD	GD	GD	GD	GD	GD	GD	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
130 pF	131	F G J K M	GD	GD	GD	GD	GD	GD	GD	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
150 pF	151	F G J K M	GK	GK	GK	GK	GK	GK	GK	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
160 pF	161	F G J K M	GK	GK	GK	GK	GK	GK	GK	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
180 pF	181	F G J K M	GK	GK	GK	GK	GK	GK	GK	HG	HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
200 pF	201	F G J K M	GB	GB	GB	GB	GB	GD	GM	HE	HE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
220 pF	221	F G J K M	GB	GB	GB	GB	GB	GD	GM	HE	HE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF				
240 pF	241	F G J K M	GB	GB	GB	GB	GB	GH	GM	HE	HE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KE	KE	KE	KE	KE	KE	KF				
270 pF	271	F G J K M	GB	GB	GB	GB	GB	GH	GM	HE	HE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KE	KE	KE	KE	KE	KE	KF				
300 pF	301	F G J K M	GB	GB	GB	GB	GB	GH	GO	HE	HE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF				
330 pF	331	F G J K M	GB	GB	GB	GB	GB	GH	GO	HE	HE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF				
360 pF	361	F G J K M	GB	GB	GB	GB	GD	GK	GO	HE	HE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF				
390 pF	391	F G J K M	GB	GB	GB	GB	GD	GK	GO	HE	HE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF				
430 pF	431	F G J K M	GB	GB	GB	GB	GD	GK	GO	HE	HE	HE	HE	HE	HE	HJ	JE	JE	JE	JE	JE	JK	JL	KF	KF	KF	KF	KF	KE	KF				
Capacitance	Capacitance Code	Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000				
		Voltage Code	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H				
		Case Size/ Series	C1812Y								C1825Y								C2220Y								C2225Y							

These products are protected under US Patent 7,172,985 & 7,670,981, other patents pending, and any foreign counterparts.

Table 1B – Capacitance Range/Selection Waterfall (1812 – 2225 Case Sizes) cont.

Capacitance	Capacitance Code	Case Size/ Series	C1812Y								C1825Y								C2220Y								C2225Y										
		Voltage Code	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H							
		Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000							
		Capacitance Tolerance	Product Availability and Chip Thickness Codes See Table 2 for Chip Thickness Dimensions																																		
470 pF	471	F G J K M	GB	GB	GB	GB	GD	GK								HE	HE	HE	HE	HE	HE	HJ	JE	JE	JE	JE	JE	JK	JL	KF	KF	KF	KF	KE	KE	KF	
510 pF	511	F G J K M	GB	GB	GB	GD	GH	GM								HE	HE	HE	HE	HG	HE	HJ	JK	JK	JK	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF	
560 pF	561	F G J K M	GB	GB	GB	GD	GH	GM								HE	HE	HE	HE	HG	HE	HJ	JK	JK	JK	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF	
620 pF	621	F G J K M	GB	GB	GB	GD	GH	GO								HE	HE	HE	HE	HG	HG	HK	JE	JE	JE	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF	
680 pF	681	F G J K M	GB	GB	GB	GD	GH	GO								HE	HE	HE	HE	HG	HG	HK	JE	JE	JE	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF	
750 pF	751	F G J K M	GB	GB	GB	GD	GK									HE	HE	HE	HG	HG	HG		JE	JE	JE	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ	
820 pF	821	F G J K M	GB	GB	GB	GD	GK									HE	HE	HE	HG	HG	HG		JE	JE	JE	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ	
910 pF	911	F G J K M	GB	GB	GB	GH	GM									HE	HE	HE	HG	HG	HG		JK	JK	JK	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ	
1,000 pF	102	F G J K M	GB	GB	GB	GH	GM									HE	HE	HE	HG	HG	HG		JK	JK	JK	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ	
1,100 pF	112	F G J K M	GB	GB	GB	GH	GO									HE	HE	HE	HG	HG	HJ		JK	JK	JK	JK	JK	JL		KE	KE	KE	KF	KF	KF		
1,200 pF	122	F G J K M	GB	GB	GB	GH	GO									HE	HE	HE	HG	HG	HJ		JK	JK	JK	JK	JK	JL		KE	KE	KE	KF	KF	KF		
1,300 pF	132	F G J K M	GB	GB	GB	GH	GO									HE	HE	HE	HG	HE	HK		JK	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH		
1,500 pF	152	F G J K M	GB	GB	GB	GH	GO									HE	HE	HE	HG	HG	HK		JK	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH		
1,600 pF	162	F G J K M	GD	GD	GD	GM										HG	HG	HG	HG	HG			JK	JK	JK	JK	JE	JN		KE	KE	KE	KF	KE	KH		
1,800 pF	182	F G J K M	GD	GD	GD	GM										HG	HG	HG	HG	HG			JK	JK	JK	JK	JE	JN		KE	KE	KE	KF	KE	KH		
2,000 pF	202	F G J K M	GH	GH	GH	GO										HG	HG	HG	HE	HJ			JK	JK	JK	JE	JK			KE	KE	KE	KF	KF	KJ		
2,200 pF	222	F G J K M	GH	GH	GH	GO										HG	HG	HG	HE	HJ			JK	JK	JK	JK	JK			KE	KE	KE	KF	KF	KJ		
2,400 pF	242	F G J K M	GK	GK	GK	GO										HG	HG	HG	HE	HK			JK	JK	JK	JE	JL			KE	KE	KE	KE	KH			
2,700 pF	272	F G J K M	GK	GK	GK	GO										HG	HG	HG	HE	HK			JK	JK	JK	JE	JL			KE	KE	KE	KE	KH			
3,000 pF	302	F G J K M	GK	GK	GK											HG	HG	HG	HG	HK			JK	JK	JK	JK	JN			KE	KE	KE	KE	KJ			
3,300 pF	332	F G J K M	GK	GK	GK											HG	HG	HG	HG	HK			JK	JK	JK	JK	JN			KE	KE	KE	KE	KJ			
3,600 pF	362	F G J K M	GM	GM	GM											HG	HG	HG	HJ				JK	JK	JK	JK	JN			KF	KF	KF	KF	KJ			
3,900 pF	392	F G J K M	GM	GM	GM											HG	HG	HG	HJ				JK	JK	JK	JK	JN			KF	KF	KF	KF	KJ			
4,300 pF	432	F G J K M	GO	GO	GO											HG	HG	HG	HJ				JK	JK	JK	JL				KF	KF	KF	KH				
4,700 pF	472	F G J K M	GO	GO	GO											HG	HG	HG	HJ				JK	JK	JK	JL				KF	KF	KF	KH				
5,100 pF	512	F G J K M	GO	GO	GO											HG	HG	HG	HK				JK	JK	JK	JN				KF	KF	KF	KH				
5,600 pF	562	F G J K M	GO	GO	GO											HG	HG	HG	HK				JK	JK	JK	JN				KF	KF	KF	KH				
6,200 pF	622	F G J K M														HJ	HJ	HJ					JK	JK	JK	JN				KF	KF	KF	KJ				
6,800 pF	682	F G J K M														HJ	HJ	HJ					JK	JK	JK	JN				KF	KF	KF	KJ				
7,500 pF	752	F G J K M														HJ	HJ	HJ					JL	JL	JL					KF	KF	KF					
8,200 pF	822	F G J K M														HJ	HJ	HJ					JL	JL	JL					KF	KF	KF					
9,100 pF	912	F G J K M														HK	HK	HK					JL	JL	JL					KH	KH	KH					
10,000 pF	103	F G J K M														HK	HK	HK					JL	JL	JL					KH	KH	KH					
12,000 pF	123	F G J K M																					JN	JN	JN					KH	KH	KH					
15,000 pF	153	F G J K M																					JN	JN	JN					KJ	KJ	KJ					
Capacitance	Capacitance Code	Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000
		Voltage Code	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H	C	B	D	F	G	Z	H
		Case Size/ Series	C1812Y								C1825Y								C2220Y								C2225Y										

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Table 2A – Chip Thickness/Tape & Reel Packaging Quantities

Thickness Code	Case Size ¹	Thickness ± Range (mm)	Paper Quantity		Plastic Quantity	
			7" Reel	13" Reel	7" Reel	13" Reel
DG	805	1.25 ± 0.15	0	0	2,500	10,000
ES	1206	1.00 ± 0.20	0	0	2,500	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EU	1206	1.60 ± 0.25	0	0	2,000	8,000
FZ	1210	1.25 ± 0.20	0	0	2,500	10,000
FM	1210	1.70 ± 0.20	0	0	2,000	8,000
FK	1210	2.10 ± 0.20	0	0	2,000	8,000
FS	1210	2.50 ± 0.30	0	0	1,000	4,000
LA	1808	1.40 ± 0.15	0	0	1,000	4,000
LB	1808	1.60 ± 0.15	0	0	1,000	4,000
LC	1808	2.00 ± 0.15	0	0	1,000	4,000
GB	1812	1.00 ± 0.10	0	0	1,000	4,000
GD	1812	1.25 ± 0.15	0	0	1,000	4,000
GH	1812	1.40 ± 0.15	0	0	1,000	4,000
GK	1812	1.60 ± 0.20	0	0	1,000	4,000
GM	1812	2.00 ± 0.20	0	0	500	2,000
GO	1812	2.50 ± 0.20	0	0	500	2,000
HE	1825	1.40 ± 0.15	0	0	1,000	4,000
HG	1825	1.60 ± 0.20	0	0	1,000	4,000
HJ	1825	2.00 ± 0.20	0	0	500	2,000
HK	1825	2.50 ± 0.20	0	0	500	2,000
JE	2220	1.40 ± 0.15	0	0	1,000	4,000
JK	2220	1.60 ± 0.20	0	0	1,000	4,000
JL	2220	2.00 ± 0.20	0	0	500	2,000
JN	2220	2.50 ± 0.20	0	0	500	2,000
KE	2225	1.40 ± 0.15	0	0	1,000	4,000
KF	2225	1.60 ± 0.20	0	0	1,000	4,000
KH	2225	2.00 ± 0.20	0	0	500	2,000
KJ	2225	2.50 ± 0.20	0	0	500	2,000
Thickness Code	Case Size ¹	Thickness ± Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
			Paper Quantity ¹		Plastic Quantity	

Package quantity based on finished chip thickness specifications.

Table 2B – Bulk Packaging Quantities

Packaging Type		Loose Packaging	
		Bulk Bag (default)	
Packaging C-Spec ¹		N/A ²	
Case Size		Packaging Quantities (pieces/unit packaging)	
EIA (in)	Metric (mm)	Minimum	Maximum
0402	1005	1	50,000
0603	1608		
0805	2012		
1206	3216		
1210	3225		
1808	4520		20,000
1812	4532		
1825	4564		
2220	5650		
2225	5664		

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial Grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for Automotive Grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding Anti-Static Bulk Bag and Automotive Grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.

Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC–7351

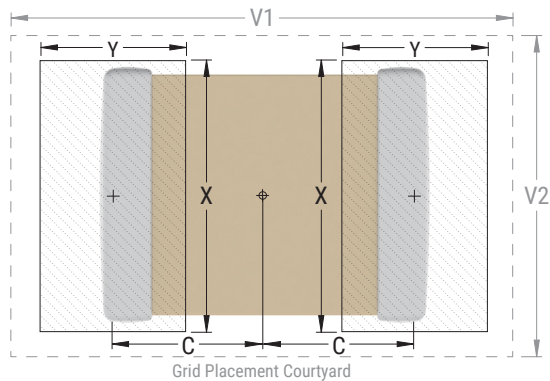
EIA Size Code	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)					Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)				
		C	Y	X	V1	V2	C	Y	X	V1	V2	C	Y	X	V1	V2
0805	2012	0.99	1.44	1.66	4.47	2.71	0.89	1.24	1.56	3.57	2.11	0.79	1.04	1.46	2.42	1.81
1206	3216	1.59	1.62	2.06	5.85	3.06	1.49	1.42	1.96	4.95	2.46	1.39	1.22	1.86	4.25	2.16
1210	3225	1.59	1.62	3.01	5.90	4.01	1.49	1.42	2.91	4.95	3.41	1.39	1.22	2.81	4.25	3.11
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.10	1.80	3.60	7.00	4.60	2.00	1.60	3.50	6.10	4.00	1.90	1.40	3.40	5.40	3.70
1825	4564	2.15	1.80	6.90	7.10	7.90	2.05	1.60	6.80	6.20	7.30	1.95	1.40	6.70	5.50	7.00
2220	5650	2.85	2.10	5.50	8.80	6.50	2.75	1.90	5.40	7.90	5.90	2.65	1.70	5.30	7.20	5.60
2225	5664	2.85	2.10	6.90	8.80	7.90	2.75	1.90	6.80	7.90	7.30	2.65	1.70	6.70	7.20	7.00

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.



Soldering Process

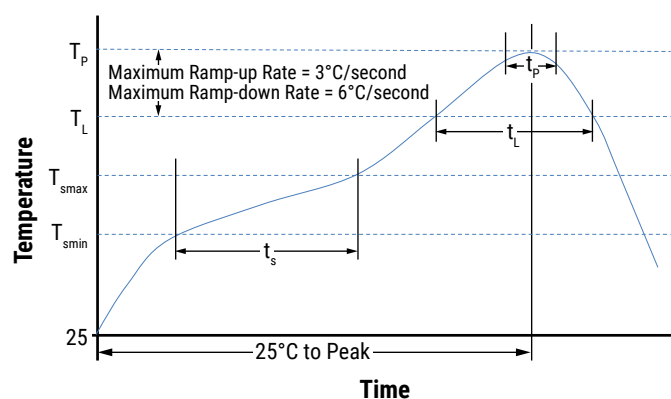
Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish	
	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T_{Smin})	100°C	150°C
Temperature Maximum (T_{Smax})	150°C	200°C
Time (t_s) from T_{Smin} to T_{Smax}	60 – 120 seconds	60 – 120 seconds
Ramp-Up Rate (T_L to T_p)	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T_p)	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t_p)	20 seconds maximum	30 seconds maximum
Ramp-Down Rate (T_p to T_L)	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum



Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

Table 4 – Performance & Reliability: Test Methods and Conditions

Stress	Reference	Test Condition	Limits										
Visual and Mechanical	KEMET Internal	No defects that may affect performance (10X)	Dimensions according KEMET Spec Sheet										
Capacitance (Cap)	KEMET Internal	$C \leq 1,000 \text{ pF}$ Frequency: 1 MHz $\pm 100 \text{ kHz}$ Voltage*: 1.0 V _{rms} $\pm 0.2 \text{ V}$ $C > 1,000 \text{ pF}$ Frequency: 1 kHz $\pm 50 \text{ Hz}$ Voltage: 1.0 V _{rms} $\pm 0.2 \text{ V}$ * See part number specification sheet for voltage	Within Tolerance										
Dissipation Factor (DF)	KEMET Internal	$C \leq 1,000 \text{ pF}$ Frequency: 1 MHz $\pm 100 \text{ kHz}$ Voltage*: 1.0 V _{rms} $\pm 0.2 \text{ V}$ $C > 1,000 \text{ pF}$ Frequency: 1 kHz $\pm 50 \text{ Hz}$ Voltage: 1.0 V _{rms} $\pm 0.2 \text{ V}$ * See part number specification sheet for voltage	Within Specification Dissipation factor (DF) maximum limit at 25°C = 0.1%										
Insulation Resistance (IR)	KEMET Internal	500 VDC applied for 120 ± 5 seconds at 25°C	Within Specification To obtain IR limit, divide M Ω - μF value by the capacitance and compare to G Ω limit. Select the lower of the two limits: 1,000 megohm microfarads or 100 G Ω .										
Temperature Coefficient of Capacitance (TCC)	KEMET Internal	Capacitance change with reference to +25°C and 0 VDC applied. * See part number specification sheet for voltage <table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>+25°C</td> </tr> <tr> <td>2</td> <td>-55°C</td> </tr> <tr> <td>3</td> <td>+25°C (Reference Temperature)</td> </tr> <tr> <td>4</td> <td>+125°C</td> </tr> </tbody> </table>	Step	Temperature (°C)	1	+25°C	2	-55°C	3	+25°C (Reference Temperature)	4	+125°C	Within Specification: $\pm 30 \text{ ppm} / ^\circ\text{C}$
Step	Temperature (°C)												
1	+25°C												
2	-55°C												
3	+25°C (Reference Temperature)												
4	+125°C												

Table 4 – Performance & Reliability: Test Methods and Conditions cont.

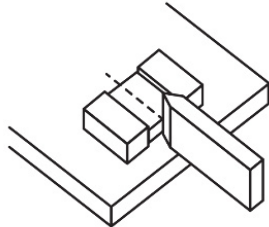
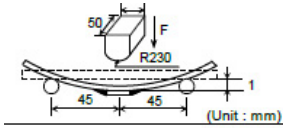
Stress	Reference	Test Condition	Limits																								
Dielectric Withstanding Voltage (DWV)	KEMET Internal	See Dielectric Withstanding Voltage (DWV) Table (5 ±1 seconds and charge/discharge not exceeding 50 mA)	Cap: Initial Limit DF: Initial Limit IR: Initial Limit Withstand test voltage without insulation breakdown or damage.																								
		<table border="1"> <thead> <tr> <th>EIA Case Size</th> <th>500 V</th> <th>630 V</th> <th>≥ 1,000 V</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td rowspan="9">150% of rated voltage</td> <td>130% of rated voltage</td> <td rowspan="9">120% of rated voltage</td> </tr> <tr> <td>0805</td> <td>< 620pF 150% of rated voltage ≥ 620pF 130% of rated voltage</td> </tr> <tr> <td>1206</td> <td>< 5.1nF 150% of rated voltage ≥ 5.1nF 130% of rated voltage</td> </tr> <tr> <td>1210</td> <td>< 7.5nF 150% of rated voltage ≥ 7.5nF 130% of rated voltage</td> </tr> <tr> <td>1808</td> <td>< 5.1nF 150% of rated voltage ≥ 5.1nF 130% of rated voltage</td> </tr> <tr> <td>1812</td> <td>< 12nF 150% of rated voltage ≥ 12nF 130% of rated voltage</td> </tr> <tr> <td>1825</td> <td>< 22nF 150% of rated voltage ≥ 22nF 130% of rated voltage</td> </tr> <tr> <td>2220</td> <td>< 27nF 150% of rated voltage ≥ 27nF 130% of rated voltage</td> </tr> <tr> <td>2225</td> <td>< 33nF 150% of rated voltage ≥ 33nF 130% of rated voltage</td> </tr> </tbody> </table>	EIA Case Size	500 V	630 V	≥ 1,000 V	0603	150% of rated voltage	130% of rated voltage	120% of rated voltage	0805	< 620pF 150% of rated voltage ≥ 620pF 130% of rated voltage	1206	< 5.1nF 150% of rated voltage ≥ 5.1nF 130% of rated voltage	1210	< 7.5nF 150% of rated voltage ≥ 7.5nF 130% of rated voltage	1808	< 5.1nF 150% of rated voltage ≥ 5.1nF 130% of rated voltage	1812	< 12nF 150% of rated voltage ≥ 12nF 130% of rated voltage	1825	< 22nF 150% of rated voltage ≥ 22nF 130% of rated voltage	2220	< 27nF 150% of rated voltage ≥ 27nF 130% of rated voltage	2225	< 33nF 150% of rated voltage ≥ 33nF 130% of rated voltage	
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Aging Rate (Maximum % Capacitance Loss/Decade Hour)	KEMET Internal	Maximum % capacitance loss/decade hour	0% Loss/Decade Hour																								
Terminal Strength	KEMET Internal	Shear stress test per specific case size, Time: 60 ±1 second.	No evidence of mechanical damage																								
		<table border="1"> <thead> <tr> <th>Case Size</th> <th>Force</th> </tr> </thead> <tbody> <tr> <td>0603</td> <td>5N</td> </tr> <tr> <td>0805</td> <td>9N</td> </tr> <tr> <td>≥ 1206</td> <td>18N</td> </tr> </tbody> </table> 	Case Size	Force	0603	5N	0805	9N	≥ 1206	18N																	
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Board Flex	AEC-Q200-005	Standard Termination System 2.0 mm Flexible Termination System 3.0 mm Test Time: 60± 5 seconds Ramp Time: 1 mm/second	No evidence of mechanical damage																								
																											
Solderability	J-STD-002	Condition: 4 hours ±15 minutes at 155°C dry bake apply all methods Test 245 ±5°C (SnPb & Pb-Free)	Visual Inspection. 95% coverage on termination. No leaching																								
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C) 2 - 3 cycles per hour Soak Time: 1 or 5 minute	Measurement at 24 hours ±4 hours after test conclusion. Cap: Initial Limit DF: Initial Limit IR: Initial Limit																								

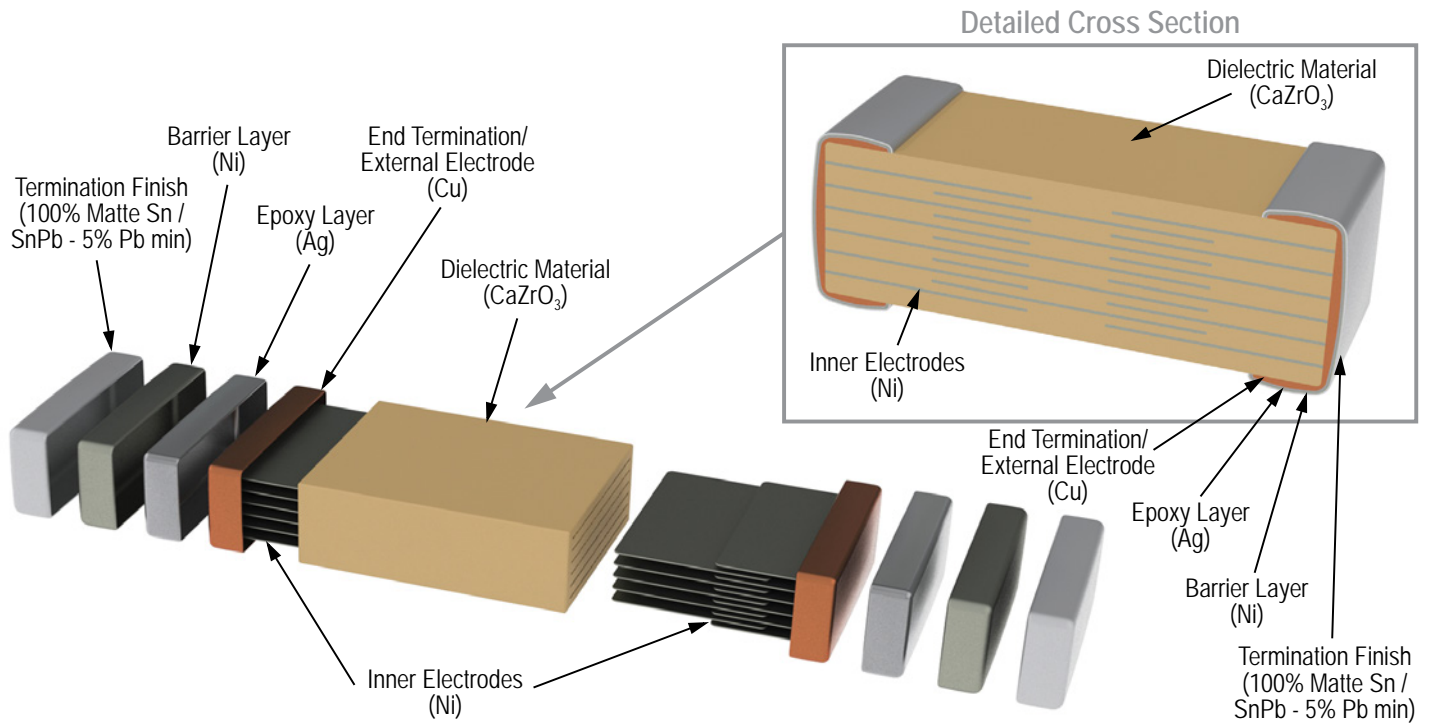
Table 4 – Performance & Reliability: Test Methods and Conditions cont.

Stress	Reference	Test Condition	Limits
Biased Humidity	MIL-STD-202 Method 103	Load Humidity: 1,000 hours 85°C/85% RH and 200 VDC maximum Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V.	Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits Cap: ±0.3% or ±0.25 pF shift IR: 10% of Initial Limit DF Limits Maximum: 0.5%
Moisture Resistance	MIL-STD-202 Method 106	Number of Cycles Required: 10, 24 hours per cycle. Steps 7a and 7b not required	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Thermal Shock	MIL-STD-202 Method 107	Number of Cycles Required: 5, (-55°C to 125°C) Dwell time 15 minutes.	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
High Temperature Life	MIL-STD-202 Method 108	1,000 hours at 125°C with 1.2 X rated voltage applied.	Within Post Environmental Limits Cap: ±0.3% or ±0.25 pF shift IR: 10% of Initial Limit DF Limits Maximum: 0.5%
Storage Life		1,000 hours at 150°C, Unpowered	
Vibration	MIL-STD-202 Method 204	5 g's for 20 minutes, 12 cycles each of 3 orientations. Test from 10 – 2,000 Hz	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Mechanical Shock	MIL-STD-202 Method 213	1,500 g's 0.5 millisecond Half-sine, Velocity Change: 15.4 feet/second (Condition F)	Cap: Initial Limit DF: Initial Limit IR: Initial Limit
Resistance to Solvents	MIL-STD-202 Method 215	Add Aqueous wash chemical OKEMCLEAN (A 6% concentrated Oakite cleaner) or equivalent. Do not use banned solvents.	Visual Inspection 10X Readable marking, no decoloration or stains. No physical damage.

Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.

Construction



Capacitor Marking (Optional)

Laser marking option is not available on:

- COG, Ultra Stable X8R and Y5V dielectric devices
- EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.

Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

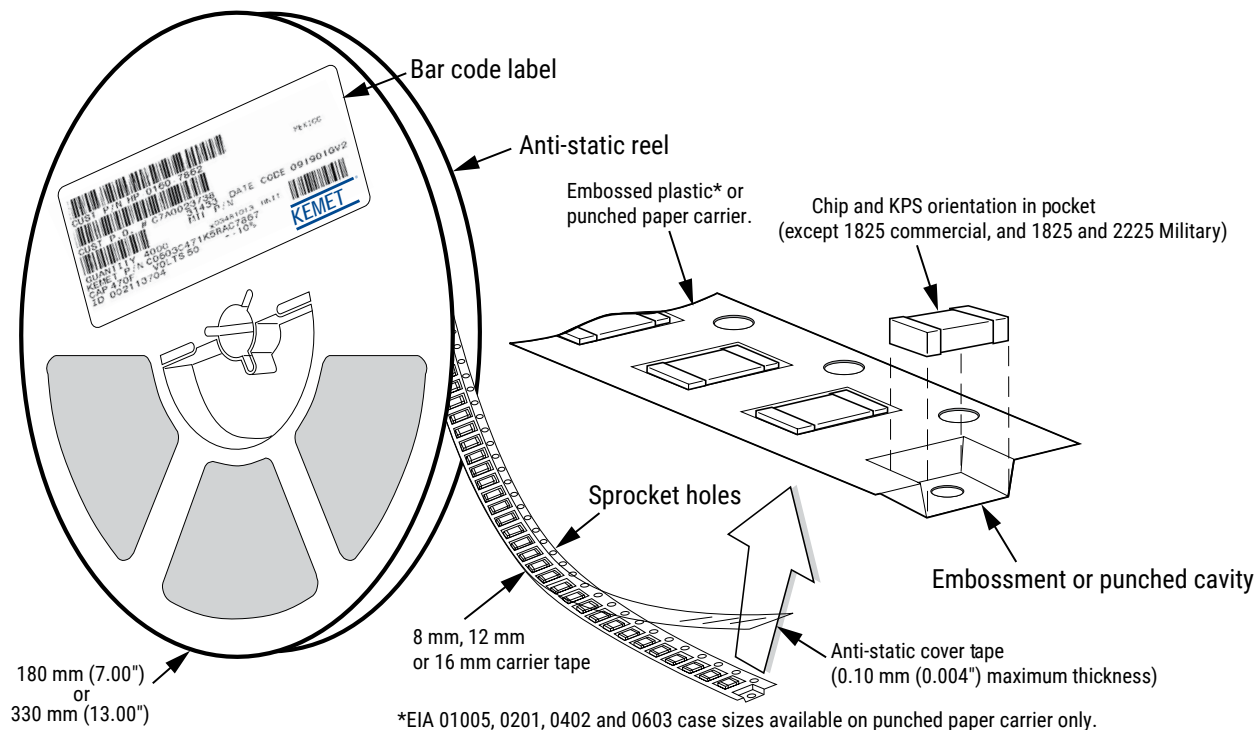


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

EIA Case Size	Tape Size (W)*	Embossed Plastic		Punched Paper	
		7" Reel	13" Reel	7" Reel	13" Reel
		Pitch (P ₁)*		Pitch (P ₁)*	
01005 – 0402	8			2	2
0603	8			4	4
0805	8	4	4	4	4
1206 – 1210	8	4	4	4	4
1805 – 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 and 2220	16	12	12		
Array 0612	8	4	4		

*Refer to Figures 1 and 2 for W and P₁ carrier tape reference locations.

*Refer to Tables 6 and 7 for tolerance specifications.

Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

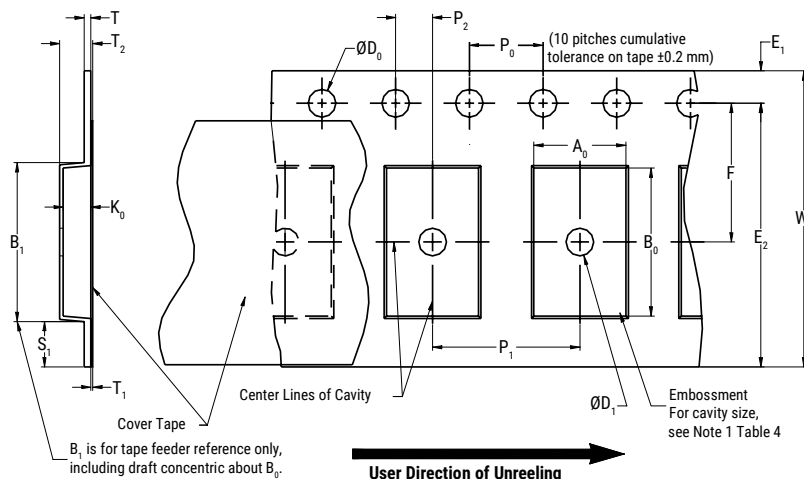


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

Constant Dimensions – Millimeters (Inches)									
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum
8 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.0 (0.039)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	25.0 (0.984)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
12 mm		1.5 (0.059)							
16 mm									
Variable Dimensions – Millimeters (Inches)									
Tape Size	Pitch	B ₁ Maximum Note 4	E ₂ Minimum	F	P ₁	T ₂ Maximum	W Maximum	A ₀ , B ₀ & K ₀	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)	Note 5	
12 mm	Single (4 mm) and double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)		
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.
2. The tape with or without components shall pass around R without damage (see Figure 6.)
3. If S₁ < 1.0 mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)
4. B₁ dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A₀, B₀ and K₀ shall surround the component with sufficient clearance that:
 - (a) the component does not protrude above the top surface of the carrier tape.
 - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)
 - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)
 - (e) for KPS product, A₀ and B₀ are measured on a plane 0.3 mm above the bottom of the pocket.
 - (f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

Figure 2 – Punched (Paper) Carrier Tape Dimensions

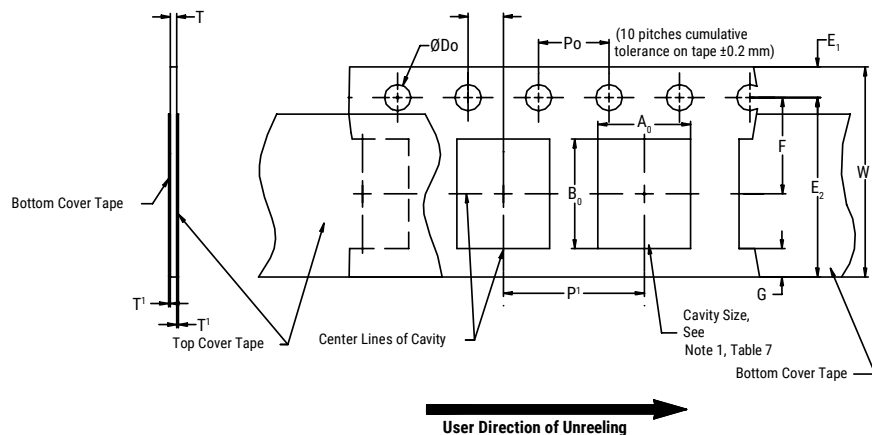


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions – Millimeters (Inches)							
Tape Size	D_0	E_1	P_0	P_2	T_1 Maximum	G Minimum	R Reference Note 2
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)
Variable Dimensions – Millimeters (Inches)							
Tape Size	Pitch	E2 Minimum	F	P_1	T Maximum	W Maximum	$A_0 B_0$
8 mm	Half (2 mm)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	2.0 ±0.05 (0.079 ±0.002)	1.1 (0.098)	8.3 (0.327)	Note 1
8 mm	Single (4 mm)			4.0 ±0.10 (0.157 ±0.004)			

- The cavity defined by A_0 , B_0 and T shall surround the component with sufficient clearance that:
 - the component does not protrude beyond either surface of the carrier tape.
 - the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
 - rotation of the component is limited to 20° maximum (see Figure 3.)
 - lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)
 - see addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- The tape with or without components shall pass around R without damage (see Figure 6.)

Packaging Information Performance Notes

- 1. Cover Tape Break Force:** 1.0 kg minimum.
- 2. Cover Tape Peel Strength:** The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

- 3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

Figure 3 – Maximum Component Rotation



Figure 4 – Maximum Lateral Movement

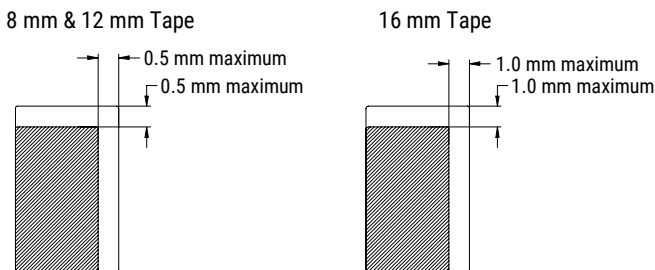


Figure 5 – Bending Radius

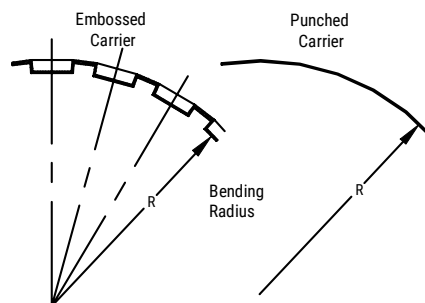
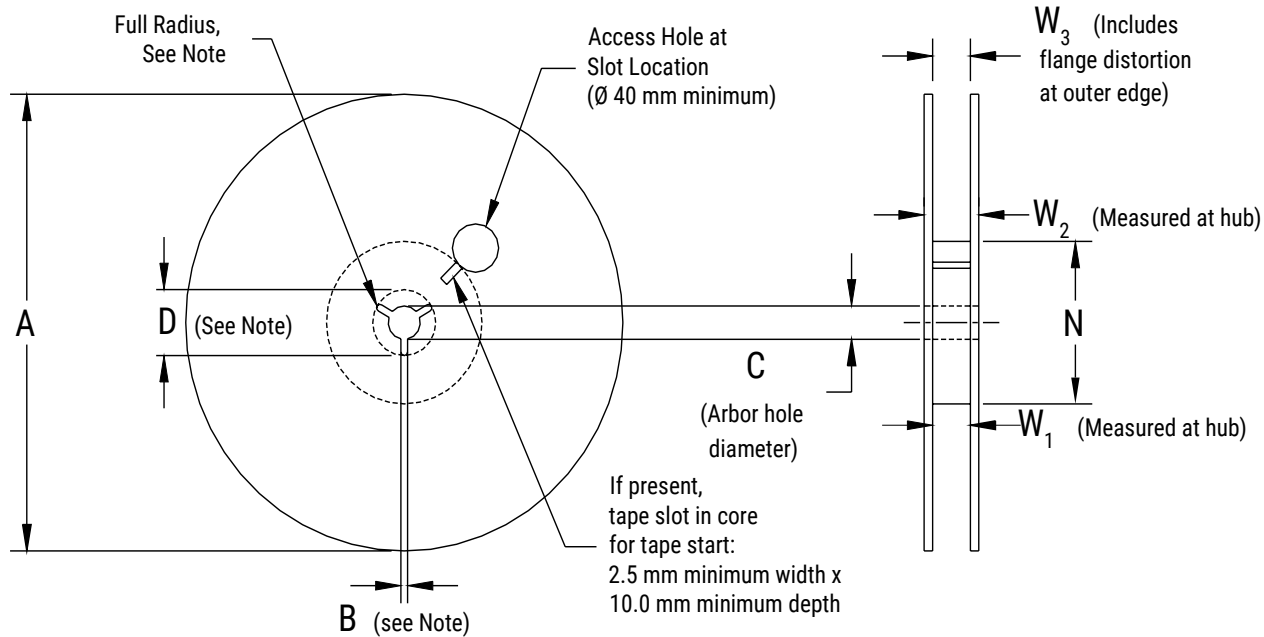


Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 – Reel Dimensions

Metric will govern

Constant Dimensions – Millimeters (Inches)				
Tape Size	A	B Minimum	C	D Minimum
8 mm	178 ±0.20 (7.008 ±0.008) or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)
12 mm				
16 mm				
Variable Dimensions – Millimeters (Inches)				
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃
8 mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape width without interference
12 mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	

Figure 7 – Tape Leader & Trailer Dimensions

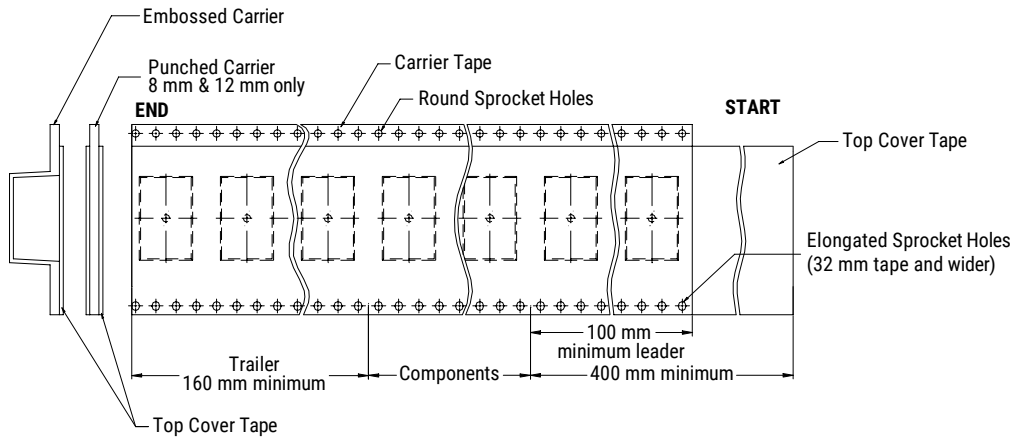
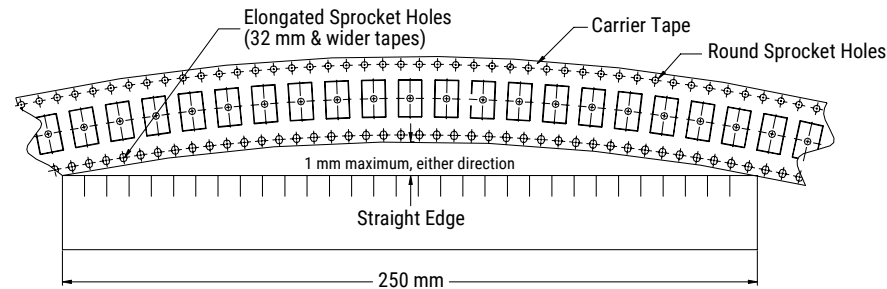


Figure 8 – Maximum Camber



Application Guide

Solder Fluxes and Cleaning

The use of water-soluble fluxes provides advantages of excellent solderability due to high activation. However, these fluxes contain organic acids that can induce arcing under high DC or AC voltages. Notable problem areas are underneath the MLCC where flux can be trapped between the ceramic material and PCB. It is therefore critical that PCBs are properly cleaned to remove all flux residue to maintain reliability.

Coating for High Voltage MLCCs

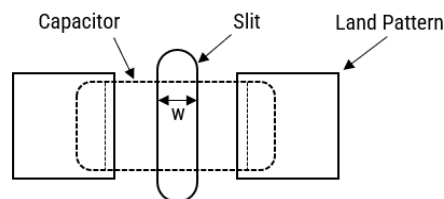
For MLCC ratings $\geq 1500\text{V}$, it is recommended to apply a conformal coating to MLCC to prevent surface arcing. To reduce possibility of inducing cracks in the MLCC, select a coating with thermal expansions close to that of the MLCC.

Dielectric	CTE (ppm/°C)
Class II BaTiO ₃	10.7
Class I CaZrO ₃	9.8

Slits in PCB

It is recommended to apply a slit in the PCB under the MLCC to improve washing of flux residue that may get trapped underneath. In some cases, it is not possible to slit entirely through the PCB due to underlying metal planes. It is also acceptable to apply a recessed slit under the MLCC which will also promote cleaning.

- Recommended for case sizes ≥ 1206
- The width (w) of the slit should be 1mm
- Length of the slit should be as short as possible to prevent damaging the MLCC due to mechanical stress of the PCB.
- Slits also reduce the risk of solder balls under MLCC which decreased the creepage distance.



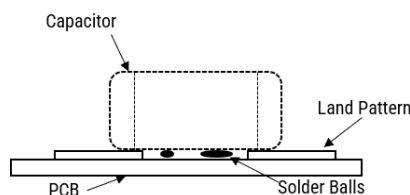
Solder Resist

If a slit cannot be applied as above, it is recommended to not use solder resist directly under the MLCC. The use of solder resist material reduces the distance between MLCC ceramic material and PCB thus making it difficult to clean.

Solder Balls

Improper reflow techniques and/or improper washing can induce solder balls under or adjacent to the MLCC. Solder balls reduce the creepage distance between the MLCC terminations and increase the risk of arcing or damage to the ceramic material. To reduce the risk of solder balls:

- Follow KEMET's solder recommendations as outlined in the datasheet.
- If performing a cleaning procedure, properly clean the PCB per KEMET's cleaning recommendations.
- Add slit to the PCB as shown above.



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